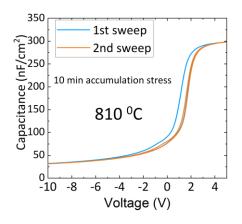


 $T_{ox} = 23.6 \text{ nm}$ $0 \quad 0.5 \quad 1 \quad 1.5 \quad 2 \quad 2.5 \quad 3$ $2\theta \text{ (deg.)}$

Fig 1: Schematic diagram of the fabricated MOSCAP structure

Fig 2: (a) Xray reflectivity plot to measure thickness of the in-situ MOCVD grown $\mathrm{Al}_2\mathrm{O}_3$



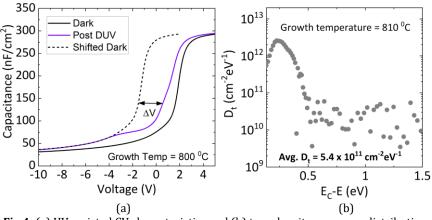


Fig 3: First & second sweep of the CV hysteresis plots for the ${\tt MOSCAP}$

Fig 4: (a) UV assisted CV characteristics and (b) trap density vs energy distribution plots for the MOSCAP

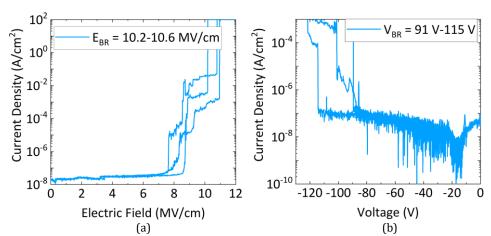


Fig 5: (a) Forward current density vs Eox and (b) reverse current density vs voltage characteristics of the MOSCAP

TABLE: Summary of the extracted trap densities

ΔQ_{T1}	ΔQ_{T2}	ΔQ_{S}	Dt
-8.3 x 10 ¹¹ cm ⁻²	-1.5 x 10 ¹¹ cm ⁻²	-7.7 x 10 ¹¹ cm ⁻²	5.4 x 10 ¹¹ cm ⁻² eV ⁻¹

Where,

 ΔQ_{T1} = Amount Fast and initially empty slow near interface traps.

 ΔQ_{T2} = Amount of Fast near interface traps.

 ΔQ_S = Amount of charge that is injected and trapped in the MOSCAP due to the accumulation stress.

 D_t = Density of all the shallow and deep (initially filled and empty) interface traps + bulk oxide hole traps.